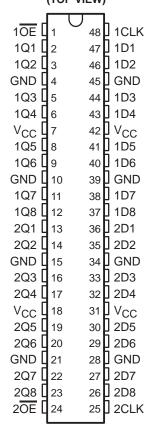
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- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

The 'ABT16374A are 16-bit edge-triggered D-type flip-flops with 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

SN54ABT16374A . . . WD PACKAGE SN74ABT16374A . . . DGG OR DL PACKAGE (TOP VIEW)



These devices can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and the increased drive provide the capability to drive bus lines without need for interface or pullup components

OE does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16374A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT16374A is characterized for operation from –40°C to 85°C.



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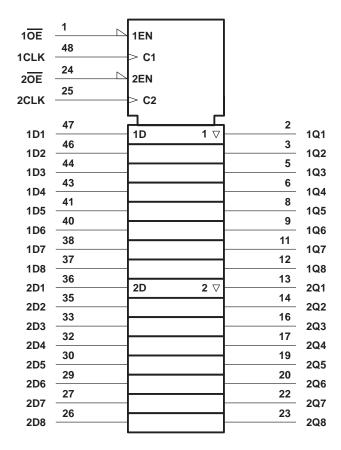


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FUNCTION TABLE (each flip-flop)

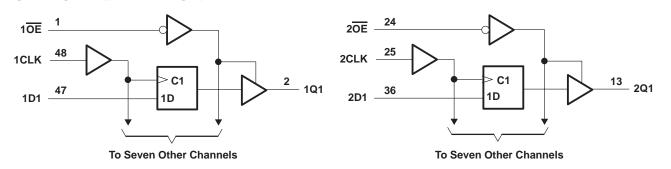
	INPUTS	OUTPUT	
OE	CLK	D	Q
L	1	Н	Н
L	\uparrow	L	L
L	H or L	Χ	Q ₀
Н	X	Χ	Z

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			SN54ABT	16374A	SN74ABT	UNIT	
			MIN	MAX	MIN	MAX	UNII
V _{CC} Supply voltage			4.5	5.5	4.5	5.5	V
VIH	V _{IH} High-level input voltage		2		2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	Vcc	0	Vcc	V
IOH	IOH High-level output current			-24		-32	mA
loL	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		200		μs/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAD	RAMETER	TEST CONDITIONS		7	T _A = 25°C	;	SN54ABT	16374A	SN74ABT1	16374A	UNIT	
PAR	KAMETER	l lesi c	CNDITIONS	MIN	TYP [†]	MAX	MIN	MAX	MIN	MAX	UNII	
VIK		$V_{CC} = 4.5 \text{ V},$	I _I = -18 mA			-1.2		-1.2		-1.2	V	
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5			
\ _{\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\}		V _{CC} = 5 V,	$I_{OH} = -3 \text{ mA}$	3			3		3		V	
VOH		V _{CC} = 4.5 V	$I_{OH} = -24 \text{ mA}$	2			2					
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2			
Vai		V00 - 45 V	I _{OL} = 48 mA			0.55		0.55			V	
VOL		V _{CC} = 4.5 V	I _{OL} = 64 mA			0.55*				0.55	V	
V _{hys}					100						mV	
IĮ		$V_{CC} = 0 \text{ to } 5.5 \text{ V}$	$V_1 = V_{CC}$ or GND			±1		±1		±1	μΑ	
l _{OZPU} ‡	‡	$V_{CC} = 0 \text{ to } 2.1 \text{ V}_{O} = 0.5 \text{ to } 2.7 \text{ V}_{O}$	V, OE = X			±50		±50		±50	μΑ	
lozpd‡	:	$V_{CC} = 2.1 \text{ V to } V_{O} = 0.5 \text{ to } 2.7$	0, V, OE = X			±50		±50		±50	μА	
lozh		V _{CC} = 2.1 V to V _O = 2.7 V, OE	5.5 V, ≥ 2 V			10		10		10	μА	
lozL		V _{CC} = 2.1 V to V _O = 0.5 V, OE				-10		-10		-10	μА	
l _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100				±100	μΑ	
ICEX	Outputs high	V _{CC} = 5.5 V,	V _O = 5.5 V			50		50		50	μΑ	
IO§		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-180	-50	-180	-50	-180	mA	
	Outputs high					2		2		2		
loo	Outputs low	V _{CC} = 5.5 V, I _O				72		72		72	_{mA}	
100	Outputs VI = VCC or (D			2		2		2	IIIA	
ΔICC¶		V _{CC} = 5.5 V, Or Other inputs at V	ne input at 3.4 V, / _{CC} or GND			1.5		1.5		1.5	mA	
Ci		V _I = 2.5 V or 0.5	V		3.5						pF	
Co		$V_0 = 2.5 \text{ V or } 0.$	5 V		9.5						pF	

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			V _{CC} = 5 V, T _A = 25°C [#]		SN54ABT16374A		SN74ABT16374A	
		MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency	0	150	0	150	0	150	MHz
t _W	Pulse duration, CLK high or low	3.3		3.3		3.3		ns
t _{su}	Setup time, data before CLK↑	1.1		1.3		1.1		ns
th	Hold time, data after CLK↑	1.3		1.5		1.3		ns

[#]These values apply only to the SN74ABT16374A.



[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] This parameter is characterized, but not production tested.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[¶] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

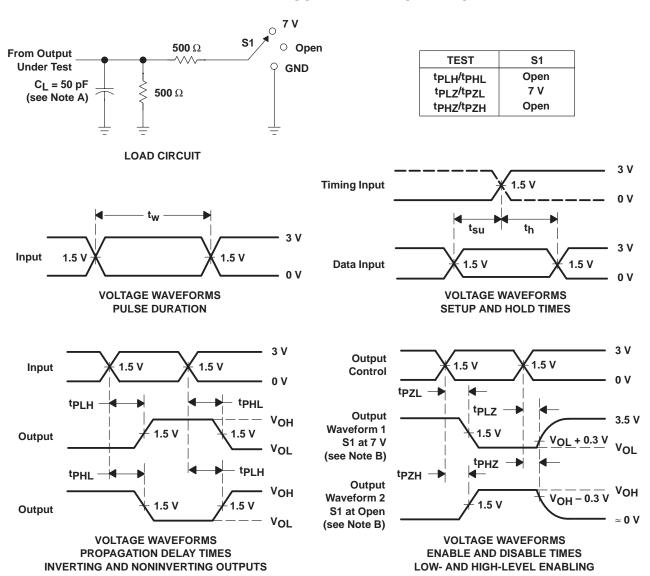
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₍	CC = 5 V 4 = 25°C	', ;	MIN	MIN MAX	UNIT
			MIN	TYP	MAX			
fmax			150			150		MHz
t _{PLH}	CLK	Q	1.8	4.3	5.7	1.5	6.9	ns
t _{PHL}		ų ,	2.7	4.7	6.1	2.2	6.9	115
^t PZH	ŌĒ	Q	1.2	3.4	4.8	0.8	6.1	ns
t _{PZL}		ų ,	1.6	3.5	4.9	1.2	5.5	115
^t PHZ	ŌĒ	Q	2.2	5.5	8.6	1.8	9.6	ns
t _{PLZ}	OE .		2.2	4.3	6.2	1.8	7.2	115

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V ₍	CC = 5 V 4 = 25°C	/, ;	MIN	MAX	UNIT
			MIN	TYP	MAX	1		
f _{max}			150			150		MHz
t _{PLH}	CLK	Q	1.8	4.3	5.4	1.8	6.2	ns
tPHL			2.7	4.7	5.6	2.7	5.9	115
^t PZH	ŌĒ	Q	1.2	3.4	4.8	1.2	5.6	ns
tPZL	OE	ų ,	1.6	3.5	4.7	1.6	5.3	115
t _{PHZ}	ŌĒ	Q	2.2	5.5	7.1	2.2	8.2	ns
tPLZ			2.2	4.3	5.8	2.2	6.6	115

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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